

RECEIVED
CENTRAL FAX CENTER

FEB 09 2005

843.43178X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): N. SUZUKI, et al.

Application No.: 10/673,214

Filed: September 30, 2003

Title: MANUFACTURING METHOD OF A SEMICONDUCTOR DEVICE
HAVING PROTECTIVE FILM ON REAR SURFACE OF
SEMICONDUCTOR WAFER (As Amended)

Group: 2823

Examiner: F. Toledo

AMENDMENTMail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 9, 2005

Sir:

In response to the Office Action mailed September 9, 2004, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Specification;

Amendments to the Claims; and

Remarks are included following the amendments.

02/10/2005 BBONNER 00000019 10673214

1

01 FC:1202

300.00 OP